CD	FC	CAT		NIC
JГ		CAI	ш	$\mathbf{I}\mathbf{V}$

CUSTOMER .

SAMPLE CODE : SH320240T023-IHC09

MASS PRODUCTION CODE . PH320240T023-IHC09

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 004

DRAWING NO. (Ver.) . LMD-PH320240T023-IHC09 (Ver.003)

PACKAGING NO. (Ver.) PKG-PH320240T023-IHC09 (Ver.002)

Customer Approved

Date:

Approved	Checked	Designer
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Preliminary specification for design input

Specification for sample approval

2019.11.21 TW RD APR

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
12/20/2018	01	001	New Drawing	-	Stephen
04/01/2019	01	002	New Sample	-	Stephen
11/15/2019	01	003	Update Spec Modify the content of the title 1.3	-	Stephen
11/20/2019	01	004	Update package drawing	-	Stephen

Total: 32 Page



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Appendix: LCM Drawing

LCM Packaging Specifications

Note:

For detailed information please refer to IC data sheet

LCD Controller: HX8238-D



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Touch Panel	Projective Capacitive Touch Panel
Screen Size(inch)	3.5 (Diagonal)
Viewing Direction	6 O'clock
Resolution	320* (R · G · B) * 240 Dots
LCD Type	Transmissive, a-Si TFT
Weight	92.9 g
Interfece	Raspberry Pi DPI /GPIO / 18 Bit RGB
Interface	(DPI_OUTPUT_FORMAT_18BIT_666_CFG1)
Other Driver	HX8238-D
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	84.02(W) * 75.36 (L) * 22.4 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	VCC	-	-0.3	+3.96	٧
Tower capping vertage	VDD	-	-0.3	+20	V
Logic Voltage	BL_PWM	-	-0.3	+20	V
Operating Temperature	T _{OP} (Ts)	Note 1	-20	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T _{ST} (Ta)	Note 2	-30	+80	$^{\circ}\!\mathbb{C}$
Storage Humidity	H _D	Ta<60 °C	-	90	%RH

Note 1: Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

1.4 DC Electrical Characteristics

Item	Symbol	Status	Condition	Min.	Тур.	Max.	Unit
Power Supply	VCC	I	VCC-GND	3.0	3.3	3.6	V
Voltage	VDD	1	VDD-GND	4.5	5.0	5.5	V
Power Supply	ICC	_	VCC=3.3v	1	30	40	mA
Current	IDD	I	VDD=5.0v	-	90	110	mA
Input Logic High Voltage	VIH	-	-	0.8*VCC	-	VCC	V
Input Logic Low Voltage	VIL	-	-	GND	-	0.2*VCC	V
Logic Voltage	BL_PWM	-	-	-	3.3	-	V
PWM Frequency	FPWM	-	-	5	-	100	KHz

Note: Maximum current from RGB full-display



1.5 Optical Characteristics

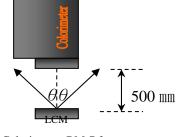
TFT LCD Panel Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	-
Response Tir	ne	Tr + Tf	-	-	40	60	ms	Note2
	Тор	ΘΥ+		-	60	-		
Viewing Angle	Bottom	ΘΥ-	CR ≥ 10	ı	60	1	Deg.	Note4
Viewing Angle	Left	ΘХ-	CR 2 10	ı	60	1	Deg.	Note4
	Right	ΘХ+		ı	60	1		
Contrast Rat	io	CR		500	600	1	1	Note3
	White	X		0.27	0.32	0.37		
	vviile	Υ		0.30	0.35	0.40		
0 1 (0)5	Red	Х		0.59	0.64	0.69		
Color of CIE	Reu	Υ	-	0.29	0.34	0.39		Natad
Coordinate (With B/L)	Green	X		0.29	0.34	0.39	_	Note1
(VVIII 12/2)	Orccii	Υ		0.56	0.61	0.66		
	Blue	Х		0.09	0.14	0.19		
	Diue	Υ		0.03	0.08	0.13		
Average Brightr Pattern=White D		IV	IF=20 mA	680	850	-	cd/m2	Note1
Luminance Unifo	ormity	YU	IF=20 mA	70	-	-	%	Note1

Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H → no wind → dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





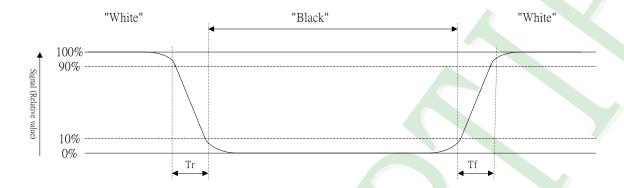
Colorimeter=BM-7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

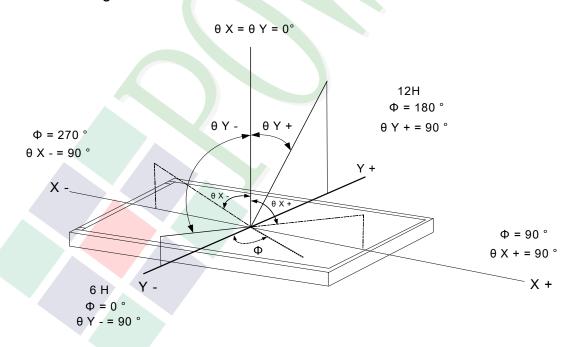
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

1.6.1 DC Characteristics

Maximum Ratings

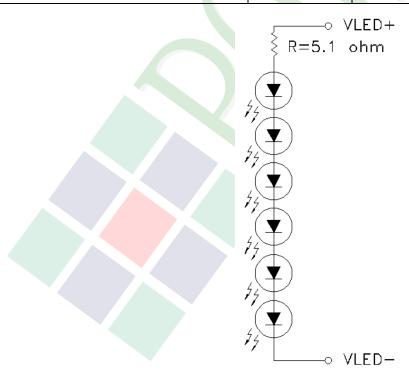
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Power Dissipation	Pd	-	-	396	-	mW
LED Forward Current	IF	1 LED	-	-	30	mA
LED Reverse Voltage	VR	1 LED	-	-	5	V

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Voltage for LED Backlight	VF	If-20m A	18.0	19.0	19.8	V
Current for LED Backlight	IF	If=20mA		20	_	mA
Color			White			

Other Description

Item	Conditions	Description
Life Tim	Ta =25°C If= 80 mA	50000 hrs





1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	3.5"
Touch Type	Projective Capacitive Touch Panel
Input Method	Finger / 5 Points Touch
Output Interface	I ² C
IC	ICNT8826

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	71.08 (W) * 53.56 (L)	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply Voltage	TP_VDD	-	-0.3	+6.0	٧
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	Tst	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TP_VDD	-	-	3.3	-	V

Touch Panel IC Read/Write Description & Register Mapping

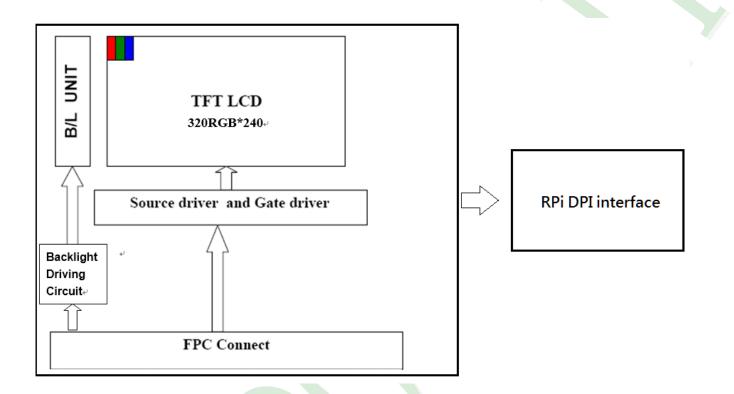
Reference: Chipone Touch Driver Porting Reference Guide.



2. MODULE STRUCTURE

2.1 Counter Drawing

- 2.1.1 LCM Mechanical Diagram
 - * See Appendix
- 2.1.2 Block Diagram





2.2 Interface Pin Description

2.2.1 (J1: DPI Interface)

Pin#	Name	Description
1	VCC	Power input for 3.3v
2	VDD	Power input for 5v
3	VS	Vertical Synchronization Signal
4	VDD	Power input for 5v
5	HS	Horizontal Synchronization Signal
6	GND	Power Ground.
7	B2	Blue Data
8	G0/G6	Green Data
9	GND	Power Ground.
10	G1/G7	Green Data
11	R3	Red Data
12	R4	Red Data
13	GPIO_A/PWM	RPi GPIO 27/ Backlight PWM
14	GND	Power Ground.
15	GPIO_B/CTP_INT	RPi GPIO 22 / PCTP Interrupt
16	GPIO_C/CTP_SCL	RPi GPIO 23 / I ² C Serial Clock Line
17	VCC	Power input for 3.3v
18	GPIO_D/CTP_SDA	RPi GPIO 24 / I ² C Serial Data Line
19	G2	Green Data
20	GND	Power Ground.



Pin#	Name	Description
21	B1/B7	Blue Data
22	GPIO_E	RPi GPIO 25
23	G3	Green Data
24	B0/B6	Blue Data
25	GND	Power Ground.
26	B5	Blue Data
27	PCLK	Peripheral Clock
28	DE	Data Enable
29	В3	Blue Data
30	GND	Power Ground.
31	B4	Blue Data
32	G4	Green Data
33	G5	Green Data
34	GND	Power Ground.
35	R5	Red Data
36	R2	Red Data
37	GPIO_F	RPi GPIO 26
38	R0/R6	Red Data
39	GND	Power Ground.
40	R1/R7	Red Data



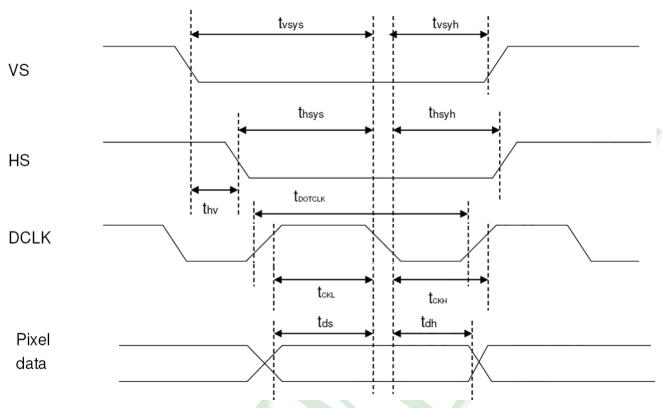
2.2.2 (J2: GPIO Interface)

Pin#	Name	Description
1	VDD	Power output for 5v
2	GPIO_A/PWM	RPi GPIO 27/ Backlight PWM
3	VDD	Power output for 5v
4	GPIO_B/CTP_INT	RPi GPIO 22 / PCTP Interrupt
5	VCC	Power output for 3.3v
6	GPIO_C/CTP_SCL	RPi GPIO 23 / I ² C Serial Clock Line
7	VCC	Power output for 3.3v
8	GPIO_D/CTP_SDA	RPi GPIO 24 / I ² C Serial Data Line
9	GND	Power Ground
10	GPIO_E	RPi GPIO 25
11	GND	Power Ground
12	GPIO_F	RPi GPIO 26



2.3 Timing Characteristics

2.3.1 AC Characteristics

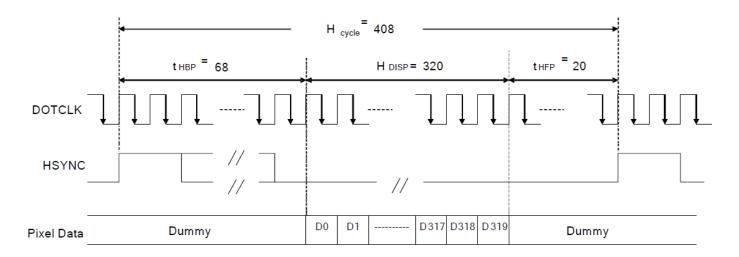


Characteristics	Symbol	Symbol Min.		Тур.		Max.		Unit	
Characteristics	Symbol	24-bit	8-bit	24- bit	8-bit	24-bit	8-bit	Oilit	
DOTCLK Frequency	fDOTCLK	-	-	6.5	19.5	10	30	MHz	
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-	-	ns	
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns	
Vertical Sync Hold Time	tvsyh	20	10	-	-	-	-	ns	
Horizontal Sync Setup Time	thsys	20	10	-	-	-	-	ns	
Horizontal Sync Hold Time	thsyh	20	10	-	•	-	-	ns	
Phase difference of Sync	thv		1	-		240		tDOTCLK	
Signal Falling Edge DOTCLK Low Period	tCKL	50	15			_		200	
				-	-	-	-	ns	
DOTCLK High Period	tCKH	50	15	-	-	-	-	ns	
Data Setup Time	tds	12	10	-	•	-	-	ns	
Data hold Time	tdh	12	10	-	-	-	-	ns	
Reset pulse width	tRES	1	0		•		•	μS	

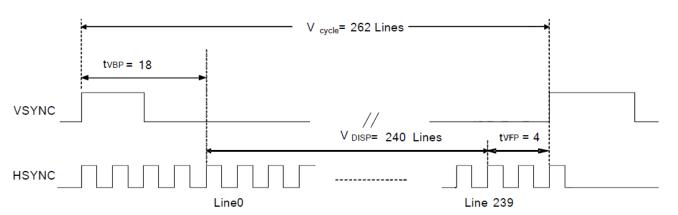
Note: External clock source must be provided to DOTCLK pin of HX8238-D. The driver will not operate if absent of the clocking signal.







(a) Horizontal Data Transaction Timing



(b) Vertical Data Transaction Timing

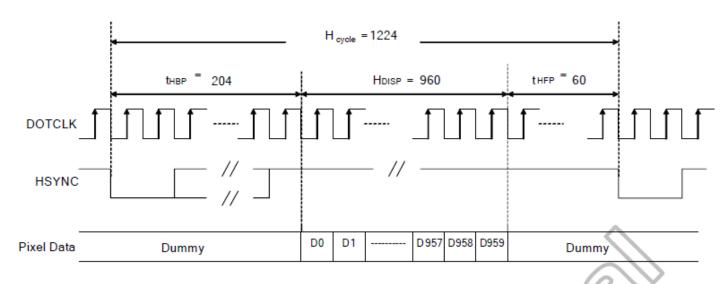
Data transaction timing in parallel RGB (24-bit) interface (SYNC mode)

Characteriet	Characteristics		Mi	n.	Ту	p.	Max.		Unit
Characteristics		Symbol	24-bit	8-bit	24- bit	8-bit	24-bit	8-bit	Onit
DOTCLK Frequence	:у	fDOTCLK	\ <u></u>	(->)	6.5	19.5	10	30	MHz
DOTCLK Period		tDOTCLK	100	33.3	<u> 154</u>	51.3	-	-	ns
Horizontal Frequen	cy (Line)	fH	<i>f</i>		14	.9	22	.35	KHz
Vertical Frequency	(Refresh)	√ f∨	\ \-	\bigcirc	6	0	9	0	Hz
Horizontal Back Po	rch	tHBP)	68	204	-	•	tDOTCLK
Horizontal Front Po	rch	tHFP	1.1	-	20	60	-	-	tDOTCLK
Horizontal Data Sta	rt Point	tHBP		•	68	204	-	•	tDOTCLK
Horizontal Blanking	Period	tHBP + tHFP	52	146	88	264	180	960	tDOTCLK
Horizontal Display	Area	HDISP	-	•	320	960	-	•	tDOTCLK
Horizontal Cycle	\bigvee	Hcycle	372	1106	408	1224	500	1920	tDOTCLK
Vertical Back Porch		tVBP	-		18		-		Lines
Vertical Front Porch	1	t∨FP	-		4		-		Lines
Vertical Data Start	Point	tVBP	-		18		-		Lines
\/avtice\\Displaint	NTSC		10)	2	2	4	7	
Vertical Blanking Period	PAL	tVBP + tVFP	20)	33		120		Lines
Pellou	PAL		12	2	25		1	12	
Martinal Display	NTSC			240		10			
Vertical Display Area PAL		VDISP	-		280(PA	(LM=0)	†	-	Lines
PAL					288(PALM=1)		†		
Vertical Cycle	NTSC	Vevele	25	0	26	52	287		Lines
vertical Cycle	PAL	Vcycle	30	0	3	13	4	00	FILIES

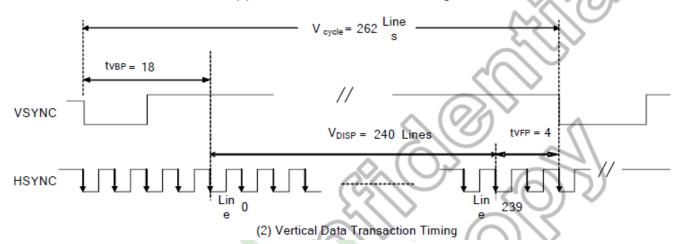
Data transaction timing in normal operating mode

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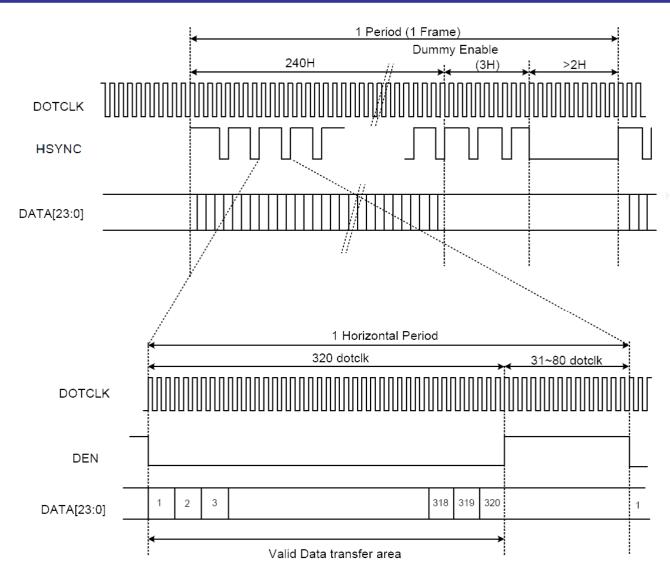


Data transaction timing in parallel RGB (8-bit) interface (SYNC mode)

Characteristics	Symbol	Min.		Тур.		Max.		Unit
Characteristics	Symbol	24-bit	8-bit	24- bit	8-bit	24-bit	8-bit	Onit
DOTCLK Frequency	fDOTCLK	- /	(-)	6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-	-	ns
Horizontal Blanking Period	tHBP + tHFP	52	146	88	264	180	960	tDOTCLK
Horizontal Display Area	HDISP	7.	-	320	960	-	-	tDOTCLK
Horizontal Cycle	Hcycle	372	1106	408	1224	500	1920	tDOTCLK
Vertical Blanking Period	t∨BP + t∨FP	2	!	-	i	4	7	Lines
Vertical Display Area	VDISP	-		24	10		-	Lines
Vertical Cycle	Vcycle	24	2	-		28	87	Lines

Data transaction timing in DE only operating mode





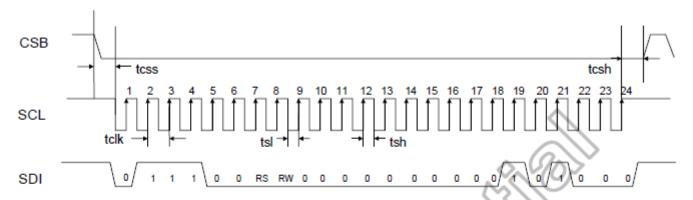
Signal timing in DE mode



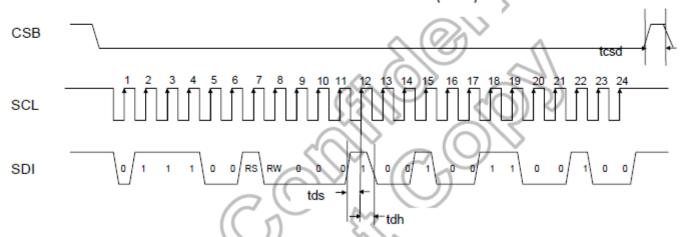


Write SPI

First Transmission (Register)

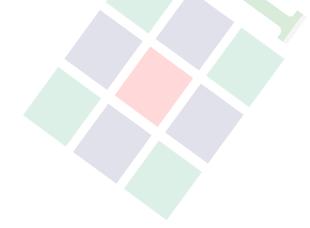


Second Transmission (Data)



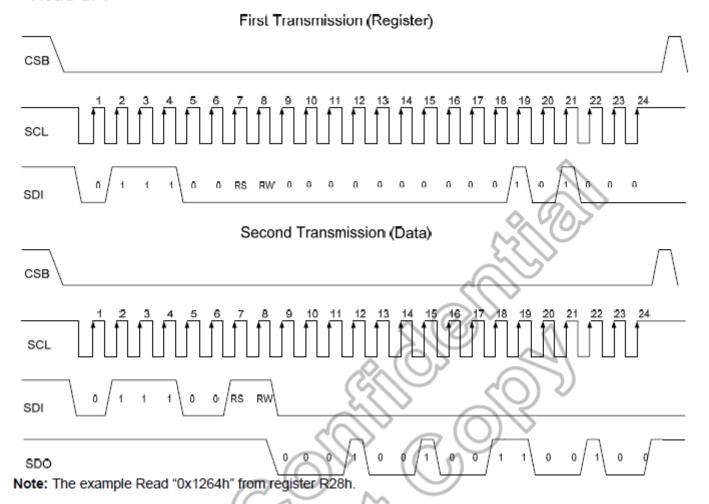
Note: The example writes "0x1264h" to register R28h. SPID connected to VSS.

(a) SPI interface timing diagram & write SPI example





Read SPI



(b) SPI interface timing diagram & read SPI example

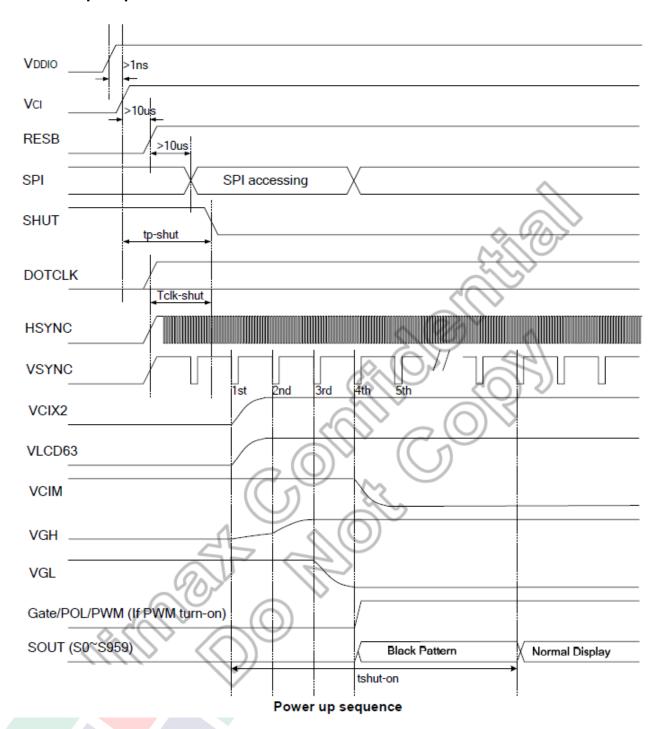
Characteristics	Symbol		Unit		
Characteristics	Symbol	Min.	Тур.	Max.	Onit
Serial Clock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	-	ns
Clock High Width	tsh	25	-	-	ns
Clock Rising Time	trs	-	-	30	ns
Clock Falling Time	tfl	-	-	30	ns
Chip Select Hold Time	tcsh	10	-	-	ns
Chip Select High Delay Time	tcsd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

SPI timing



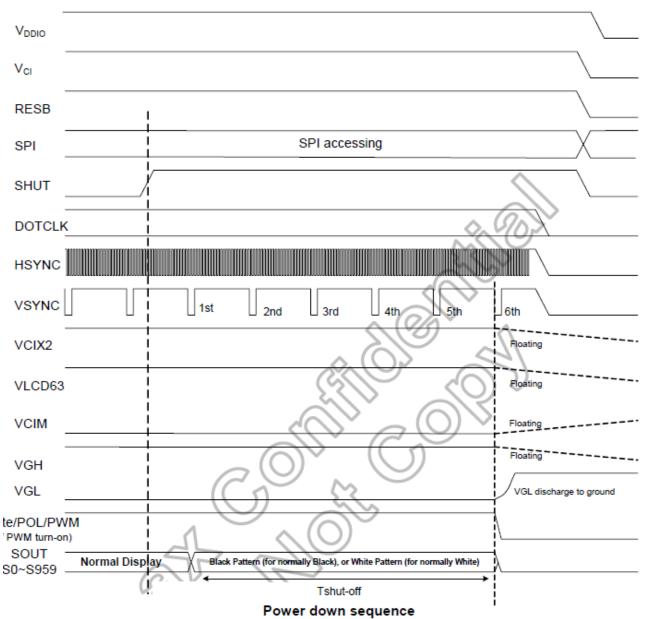
2.4 Power Sequence

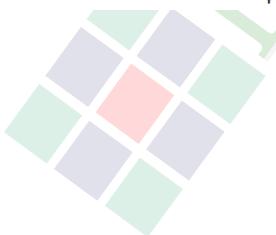
2.4.1 Power up sequence





2.4.2 Power down sequence

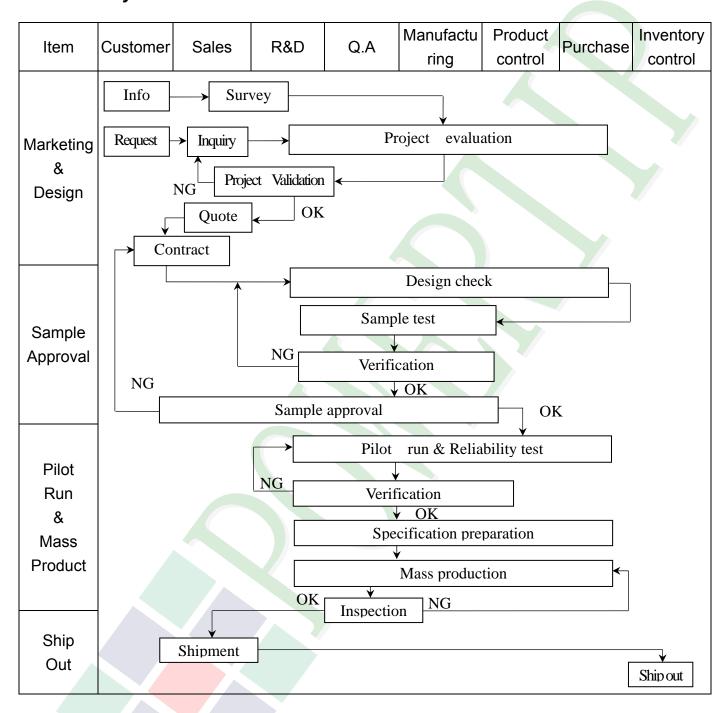




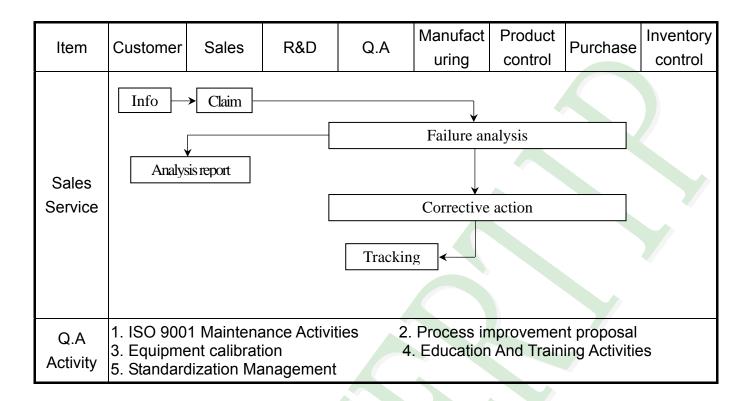


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

♦Scope: The document shall be applied to TFT-LCD Module for 3. 5" −15" (Ver.B01).

♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.

◆Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5

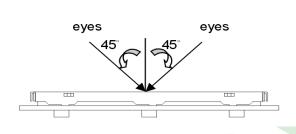
♦OUT Going Defect Level: Sampling.

♦Standard of the product appearance test:

a. Manner of appearance test:

(1). The test best be under $20W\times2$ fluorescent light(about 300lux ~500 lux), and distance of view must be at $30\sim40$ cm.

(2). The test direction is base on about around 45° of vertical line.



5% Brightness

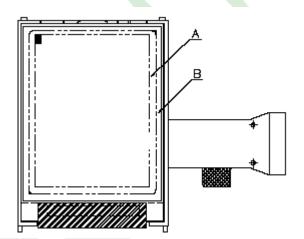
ND fliter

30~40 cm

LCD panel

2.5~3cm

(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)

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Φ Specification For TFT-LCD Module 3. 5"...~15"...:

(Ver.B01)↔

NO₊¹	Item₽			Criteri	on∢		Level⊍		
			1. 1The part number is inconsistent with work order of production. √						
01₺	Product condition.	1. 2 Mix	1. 2 Mixed product types.4						
		1. 3 Asse	embled i	n inverse direction.«	,		Major		
02₽	Quantity₽	2. 1The	quantity	is inconsistent with	work order of produ	ction.€	Major		
03₽	Outline dimension		luct dim ram.₽	ension and structu	re must conform to	structure	Major		
		4. 1 Miss	sing line	character and icon.	ت		Major		
		4. 2 No f	function	or no display.₽			Major		
04-	T1 1 T	4. 3 Disp	olay mal	function. ↩			Major		
04₽	Electrical Testing	4.4 LC	D viewir	ng angle defect.√			Major		
		4. 5 Current consumption exceeds product specifications.₽							
		l	4. 6Mura cannot be seen through 5% ND filter at 50% Gray 4, should be judged by the viewing angle of 90 degree.4						
		<u>ا</u>		Item∉	Acceptance (Q'ty)	. Le			
				Bright Dot	Acceptance (Q ty)	₽			
	Dot defect«		Dot	Dark Dot	≦ 5₽	₽			
	₽ delect*		Defect.	Joint Dot ↔		ę.			
05₽	(Bright dot,↓ Dark dot) ↓			Total₽	<u>≨</u> 7₽	₽.	Minor		
00.	On -display↔	5. 1 Insp	pection		full black, Red, G	reen and	Minor		
	₽	5 2 It is	defined	blue scree					
			 5. 2 It is defined as dot defect if defect area >1/2 dot. 5. 3 The distance between two dot defect ≥5 mm. 						
		5. 4 Bri	ght dot t	hat can not be seen	through 5% ND filter	r. ← ^J			
h		-	7						



◆Specification For TFT-LCD Module 3. 5″~15″:

(Ver.B01)↓

NO↔	Item₽			<u></u>	Crit	erion₽			Level	-
	t t	6. 1 Ro	und type (Non-displa	y or dis	splay):↵				
	ψ.		Dimensio	n (diamete	r : Ф)∉		ice (Q'ty)	₽		
	ι. Φ					A area₽	B area	€		
	Black or white-			Φ ≤ 0.		Ignore₽	4	₽3		
	Dot, scratch,↓		0.25 < Φ ≦ 0.50₽			5₽	Ignore₽			
	contamination↓		Φ > 0.50			0∻	_ 	₽		
	Round type√		•	Total₽		5₽		₽		
	→ X + +	€ 6. 2 Lii	ne type(No	n-display o	r displa	ay):↵				
	<u> Y.</u> ,	mo	dule size∉	Length	W	idth (W)₽	Acceptanc			
06₽	T			(L)₽		W ≤ 0.03¢	A area₽	B area∉	Minor	F
	$\Phi = (x+y)/2\psi$ Line type			₽ L ≤10.0₽	0.03	<w 0.05€<="" td="" ≤=""><td>Ignore∂ 4∂</td><td> </td><td></td><td></td></w>	Ignore∂ 4∂	 		
				I < 5 0.1		<w <u="">≤ 0.10₽</w>	2€			
		Line type↓ ∫ \ \frac{1}{2} W_+	3.5" to less 9"↔			W >0.10₽	As round	Ignore		
				47			type∉			
					Tota		5₽	47		
	→ _{L+} +					W ≤ 0.05¢	0	4⁻		
	L₽		00 / 150	L ≦10.0₽	0.05	<w <u="">≦ 0.10₽</w>	5₽			
		• 9	' to 15"₽	47		W >0.10€	As round type₽	Ignore		
				Total∉			5₽	4		
		4								1
			Dimension	(diameter:	Φ)-□		nce (Q'ty)∉			
				•		A area₽	Bare	£ a ₽		
	Polarizer↔			$\Phi \leq 0.25 e$		Ignore₽				
07₽			$0.25 < \Phi \leq 0.50$		ę.	4₽		47		÷
	Bubble∉		0.50 <	$\Phi \leq 0.80$	4	14	Ignoi	re↩		
				Φ >0.80	to.	0↔		₽		
			7	Total₽		5₽		ت		



◆Specification For TFT-LCD Module 3. 5_~15_":

(Ver.B01)↔

41	
Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1 General glass chip: 8. 1.1 Chip on panel surface and crack between panels: SP Ye [NG] X Y X Y Seal width X Y Seal width Crack can't enter viewing area Crack can't exceed the half of SP width.	Minor



◆Specification For TFT-LCD Module 3. 5″_~15″ :

(Ver.B01)↔

NO₽	Item∉	Criterion₽	Level*
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:	
		X_{1} Y_{2} Z_{3} φ $\stackrel{\checkmark}{=} 1/5 \text{ a.e.} \text{Crack can't enter} Z \leq 1/2 \text{ t.e.}$	
08₽	The crack of glass↓	Crack can't exceed the half of SP width. Solution 2	Minor⊹
	-	8.2.1 Chip on electrode pad:	
		X X Y Z X Y Z X Y Z	
		X X	
		Front e $\leq ae$ $\leq 1/2 \text{ We}$ $\leq te$	
		Back φ $\leq a\varphi$ $\leq W\varphi$ $\leq 1/2 t\varphi$	



◆Specification For TFT-LCD Module 3. 5″...~15″ :

(Ver.B01)↓

NO Item Criterion Criterion	Level
Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: X: The crack of glass O If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8. 2. 3 Glass remain: X: The width of crack. W: terminal length a: LCD side length X: The width of crack. W: terminal length a: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The width of crack. W: terminal length S: LCD side length X: The width of crack. W: terminal length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The width of crack W: terminal length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length X: The thickness of glass S: LCD side length S: LCD sid	Level. Minor ✓



◆Specification For TFT-LCD Module 3. 5″ ~15″ =

(Ver.B01)↔

· NO	Item₽	Criterion.	Level₽
09↔	Backlight elements↓	9. 1 Backlight can't work normally.↓	
		9. 2 Backlight doesn't light or color is wrong.↔	
		9. 3 Illumination source flickers when lit.	Major₽
	General appearance∂	10. 1Pin type > quantity > dimension must match type in structure diagram.€	Major∂
		10. 2 No short circuits in components on PCB or FPC.	Major⊍
		10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major₽
10⊷		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor↓
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor∂
		10.6 The PCB or FPC between B/L assembled distance(PCB or ↓ FPC) is ≤1.5 mm.↓	Minor∂



4. RELIABILITY TEST

4.1 **Reliability Test Condition**

(Ver.B01)

5℃					
(5mins)					
20 Cycle					
rge:					
Apply 250 V with 5 times					
ach polarity +/-					
1.Temperature ambiance : 15° C \sim 35° C					
2.Humidity relative : 30%~60%					
3.Energy Storage Capacitance(Cs+Cd): 150pF±10%					
4.Discharge Resistance(Rd): 330 Ω±10%					
5.Discharge, mode of operation :					
Single Discharge (time between successive discharges at least 1 sec)					
(Tolerance if the output voltage indication: ±5%) 1.Sine wave 10~55 Hz frequency (1 min/sweep)					
2. The amplitude of vibration :1. 5 mm 3. Each direction (X \ Y \ Z) duration for 2 Hrs					
t (cm)					
 1time					

©Result Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state) Temperature: +20~30°C

Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

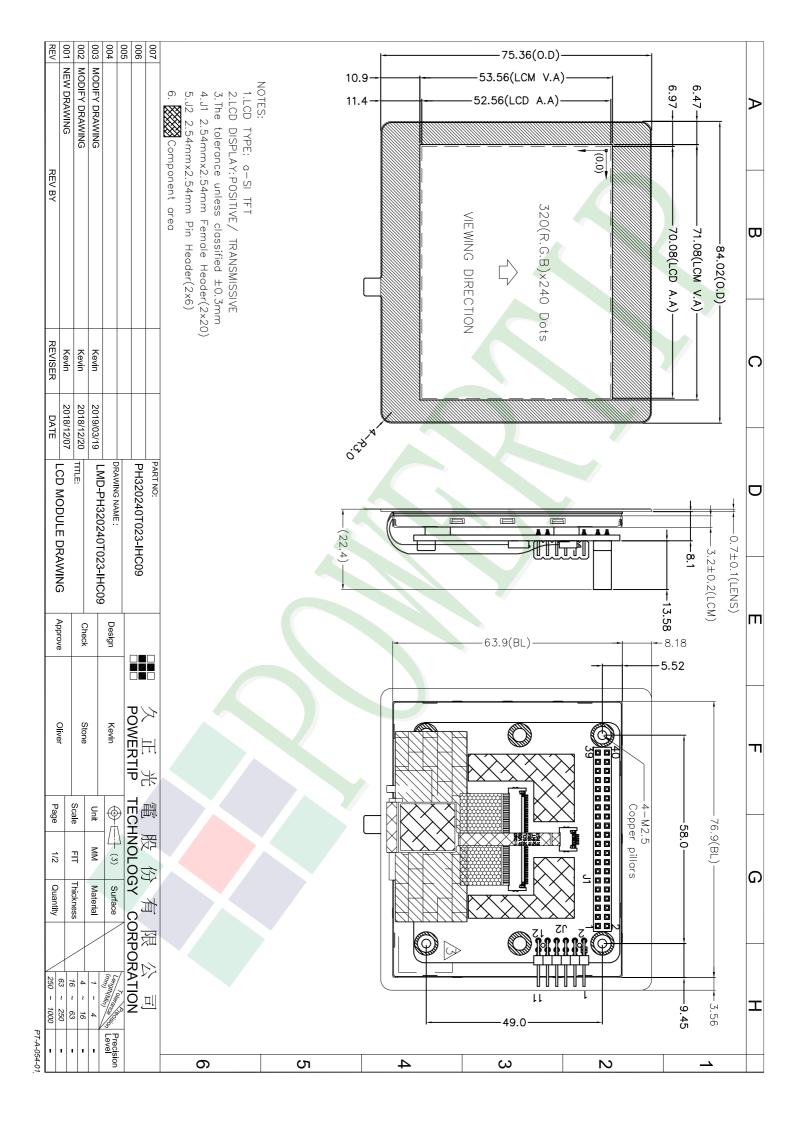
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Check Contact Approve Ver.002 LCM包裝規格書 PKG-PH320240T023-IHC09 Oliver Stone Kevin Documents NO. LCM Packaging Specifications 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Total Weight Quantity 84.02 X 75.36 1 成品 (LCM) PH320240T023-IHC09 0.0746 72 5.3712 2 氣泡袋(1)Bubble Bag BAG000000005 150 X 120 0.002 72 0.144 3 A2-1隔板(2)A2-1 Partition BX29500072BZBA 295 X 72 X 3.0 0.0109 42 0.4578 4 B2-1隔板(4)B2-1 Partition BX24500072BZBA 245 X 72 X 3.0 0.0094 18 0.1692 5 290 X 240 X 10 18 海綿墊(4)Foam Rubber Cushion OTFOAM00006ABA 0.02 0.36 C3-3内盒(5)Product Box 310 X 255 X 116 0.17 6 BX31025511AABA 6 1.02 7 0.83 外紙箱(6)Carton BX52732536CCBA 527 X 325 X 360 0.83 1 8 9 2.一 整箱總重量 (Total LCD Weight in carton): 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)Quantity Of Spacer: A2-1隔板 X 7 , B2-1隔板 X 3 (2)Total LCM quantity in carton: quantity per box x no of boxes 6 72 (4) 海綿墊· Foam Rubber Cushion (1) 氣泡袋+LCM Bubble Bag+LCM (2)(3)隔板 Partition (註 Remark 1) (4) 海綿墊 (6)外紙箱 Foam Rubber Cushion Carton (5) C3-3内盒 Product Box 特 記 項 (REMARK) 1. LCM排放示意圖(前後<mark>間隔不放置)</mark>: 1. LCM placed as figure showing: (First and last slot should be empty) 類類(LCM) X 1pcs.